

BS1100N-2A1

Order Code: BS1100N-2A1

Version: A1 2015-01-12

Thyristor Surge Suppresser

- Features
- Excellent capability of absorbing transient surge
- Quick response to surge voltage (nS Level)
- Eliminates overvoltage caused by fast rising transients

• Moisture sensitivity level: level 1

Application Information

- Weight 88 mg
- Non-degenerative
- Uni-directional

SLIC





Package (top view)



Agency Approvals

Icon	Description
RoHS	Compliance with 2011/65/EU
HF	Compliance withIEC61249-2-21:2003





Part Number and Electrical Parameter

	Idrm@Vi	ORM(PIN2-1、3)	Vs ⁽¹⁾ @Is(pir	N2-1、3)	VT@IT(PIN2	2-1、3)	VF@IF(F	PIN1、3-2)	IH(PIN2-1、3)	Co ⁽²⁾ (PIN2-1、3)
Part Number	μA	V	V(MAX)	mA	V	Α	V	mA	mA	pF
	MAX	Pin2 to1,3	Pin2 to1,3		MAX		MAX		MIN	MAX
BS1100N-2A1	5	95	130	800	4	2.2	1	10	120	100

Absolute maximum ratings measured at T_A = 25°C RH = 45%-75% (unless otherwise noted).

①Vs is measured at 100KV/S

(2) Off-state Capacitance is measured at VDC=2V,VRMS=1V,f=1MHz



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B11N2A1: Part Number

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Part Numbering System

BS	1100	Ν	- 2	А	1
(1)	(2)	(3)	(4)	(5)	(6)

(1)Bencent Semiconductor Surge Arrester

(2)Off state Voltage, e.g: $1100=110 \times 10^{0}=110$ V.

(3) Package : SMB-T

(4) 2 Lines Protection

(5) Rating Surge Voltage: 2KV(10/700µS)

(6)Polarity: Uni-directional

V-I Curve

Parameters	Definition
Vdrm	Peak Off-state Voltage
Idrm	Off-stateCurrent
Vs	Switching Voltage
Is	Switching Current
Ін	Holding Current
VT	On-state Voltage
Іт	On-state Current
$V_{\rm F}$	Forward on-state voltage
$I_{\rm F}$	Forward current
Со	Off-state Capacitance



Surge Ratings

Current Waveform	5/320µs*	8/20µs	10/1000µs
Voltage Waveform	10/700µs*	1.2/50µs	10/1000µs
Ірр	50A	300A	35A

-Peak pulse current rating (I_{PP}) is repetitive and guaranteed for the life of the product;

-Bencent makes the test for $5/320\mu$ s@50A* (10/700 μ s@2KV), $8/20\mu$ s@300A(1.2/50 μ s@600V),but for other IPP value derived from experience is just for reference only. Bencent will not take any obligation for these parameters, so before applying our parts, please make sure to verify the parameters listed in the above table.

Mark

Thermal Considerations

Symbol	Parameter	Value	Unit
T_{J}	Operating Junction Temperature Range	-40 to +150	°C
Ts	Storage Temperature Range	-60 to +150	°C

Physical Characteristics

Lead Material	Copper Alloy
Body Material	UL recognized epoxy meeting flammability classification 94V-0
Terminal Finish	100% Matte-Tin Plated

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Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications

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Environmental Characteristics

Testing Items	Technical Standards
High Temperature Reverse Bias Test	Temperature: 150±3°С, Bias=80%V _{DRM} Time:168H
High Temperature Life Test	Temperature: 150°C Time:168H
High-low Temperature Cycle Test	Temperature: From -40°C to125°C Dwell time: 30min, 10-100 cycles
High Temperature & High Humidity Test	Temperature: 85°CHumidity:85% Test time:168H
Pressure Cooker Test	Temperature: 121°C, 2atm. Humidity:100% Test time: 24H to 168H
Resistance of Soldering Heat	Temperature: 260±5°C Time of dip soldering: 10s, 3times

Note: The above testing items can be specified by customers by contacting Bencent service

Product Dimensions



REF	mm	inch
А	5.4±0.3	0.213±0.012
В	3.3±0.3	0.130±0.012
С	0.7±0.03	0.028±0.001
D	2.0±0.2	0.079±0.008
Е	0.9±0.2	0.035±0.008
F	1.32±0.3	0.052±0.012
G	1.13±0.3	0.045±0.012
Н	2±0.3	0.079±0.012
Ι	0.25±0.05	0.010±0.002

Recommended Soldering Pad



REF	mm	inch
А	3.4	0.134
В	2.5	0.098
С	1.6	0.059
D	1.8	0.059
Е	0.9	0.035
F	0.7	0.032

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Reflow Profile

I	Refl	ow Condition	Pb-Free Assembly
	Temperature Min.		+150°C
Pre Heat		emperature Max.	+200°C
	Ti	me(Min to Max)	60 – 180 secs.
Average ramp up rate(Liquidus Temp(T_L) to peak)		3°C/sec. Max.	
Ts(max) to	Τl・	Ramp-up Rate	3°C/sec. Max.
Reflow	- Temperature (T _L) (Liquidus)		+217°C
		- Temperature (T _L)	60 – 150 secs.
Peak Temp) (T ₁	p)	+(260+0/-5)°C
Time within 5°C of actual Peak Temp (T_P)		30secs.	
Ramp-down Rate		6°C/sec. Max.	
Time 25°C to peak Temp (T_P)		8 min. Max.	
Do not exc	eed		+260°C



Package Reel Information



REF	mm	inch
А	3.65+/-0.3	0.144+/-0.012
В	5.69+/-0.3	0.244+/0012
d	1.5+/-0.1	0.059+/-0.004
D	330.0	13.0
D1	100+/-3	3.937+/-0.118
D2	13+/-0.3	0.512+/-0.012
Е	1.5+/-0.2	0.059+/-0.008
F	5.65+/-0.2	0.222+/-0.008
Р	8.0+/-0.2	0.315+/-0.008
P0	4.0+/-0.2	0.157+/-0.008
P1	2.0+/-0.2	0.079+/-0.008
W	12.0+/-0.2	0.472+/-0.008
W1	16.8+/-2.0	0.661+/-0.079

Outline	Reel (pcs)	Per Carton (pcs)	Reel Diameters (mm)	Carton Size(mm)		
				L	W	Н
Taping	3,000	24,000	330	360	360	380

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